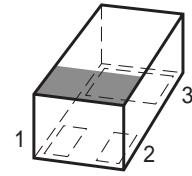


**NPN Silicon RF Transistor\***

- Low voltage/ Low current operation
- Transition frequency of 14 GHz
- High insertion gain
- Ideal for low current amplifiers and oscillators
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101

\* Short term description



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration			Package
BFR340L3	FA	1 = B	2 = E	3 = C	TSLP-3-1

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	6	V
Collector-emitter voltage	$V_{CES}$	15	
Collector-base voltage	$V_{CBO}$	15	
Emitter-base voltage	$V_{EBO}$	2	
Collector current	$I_C$	10	mA
Base current	$I_B$	2	
Total power dissipation <sup>2)</sup> $T_S \leq 120^\circ\text{C}$	$P_{tot}$	60	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>3)</sup>	$R_{thJS}$	tbd	K/W

<sup>1</sup>Pb-containing package may be available upon special request

<sup>2</sup> $T_S$  is measured on the collector lead at the soldering point to the pcb

<sup>3</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	6	9	-	V
Collector-emitter cutoff current $V_{CE} = 15 \text{ V}, V_{BE} = 0$	$I_{CES}$	-	-	10	$\mu\text{A}$
Collector-base cutoff current $V_{CB} = 5 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	1	$\mu\text{A}$
DC current gain $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}$ , pulse measured	$h_{FE}$	90	120	160	-

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Transition frequency $I_C = 6 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1 \text{ GHz}$	$f_T$	10	14	-	GHz
Collector-base capacitance $V_{CB} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , emitter grounded}$	$C_{cb}$	-	0.17	0.4	pF
Collector emitter capacitance $V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0 \text{ , base grounded}$	$C_{ce}$	-	0.13	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0 \text{ , collector grounded}$	$C_{eb}$	-	0.12	-	
Noise figure $I_C = 1 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1.8 \text{ GHz}$	$F_{\text{min}}$	-	1.15	-	dB
Power gain, maximum stable <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}} \text{ , } Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$	$G_{\text{ms}}$	-	17.5	-	-
Power gain, maximum available <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{\text{Sopt}} \text{ , } Z_L = Z_{\text{Lopt}}, f = 3 \text{ GHz}$	$G_{\text{ma}}$	-	13	-	dB
Transducer gain $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega \text{ , } f = 1.8 \text{ GHz}$ $f = 3 \text{ GHz}$	$ S_{21e} ^2$	-	14	-	dB
-	-	-	10	-	
Third order intercept point at output <sup>2)</sup> $V_{CE} = 3 \text{ V}, I_C = 5 \text{ mA}, f = 1.8 \text{ GHz}$ $Z_S = Z_L = 50\Omega$	$IP_3$	-	12.5	-	dBm
1dB Compression point at output $I_C = 5 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50\Omega \text{ , } f = 1.8 \text{ GHz}$	$P_{-1\text{dB}}$	-	-1	-	

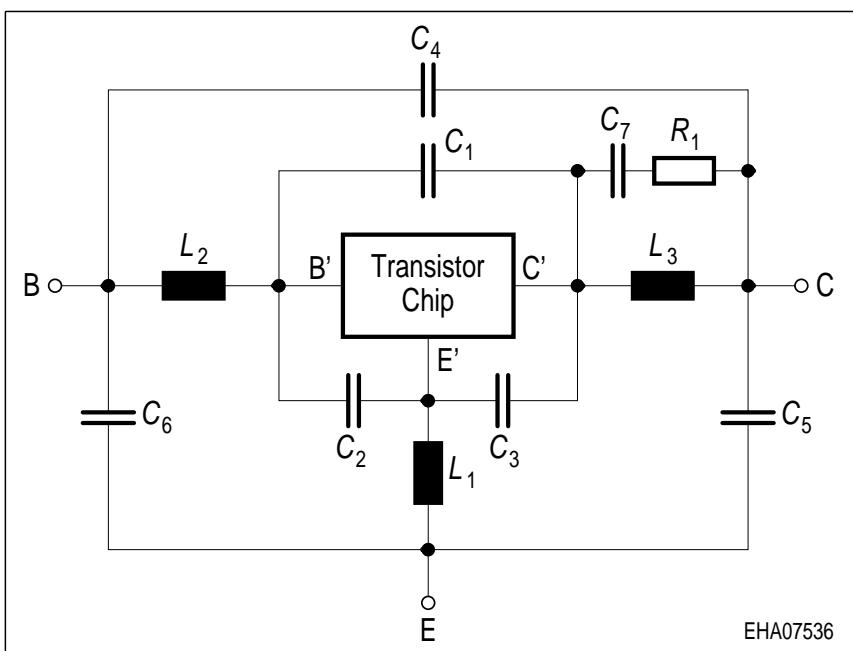
<sup>1</sup> $G_{\text{ma}} = |S_{21e}| / S_{12e} \text{ (k-(k}^2-1)^{1/2})$ ,  $G_{\text{ms}} = |S_{21e}| / S_{12e}$ 
<sup>2</sup>IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is  $50\Omega$  from 0.1 MHz to 6 GHz

**SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):**
**Transistor Chip Data:**

IS =	6.12	fA	BF =	98.48	-	NF =	0.4213	-
VAF =	42.228	V	IKF =	103	mA	ISE =	11.768	nA
NE =	2.4753	-	BR =	19.61	-	NR =	0.3253	-
VAR =	16.777	V	IKR =	0.834	A	ISC =	3.632	nA
NC =	0.8956	-	RB =	59.99	$\Omega$	IRB =	0.01	mA
RBM =	0.2403	$\Omega$	RE =	3.677	-	RC =	5.2493	$\Omega$
CJE =	182	fF	VJE =	0.626	V	MJE =	0.4172	-
TF =	10.3	ps	XTF =	0	-	VTF =	0.262	V
ITF =	0.0017	mA	PTF =	0	deg	CJC =	222.63	fF
VJC =	0.5487	V	MJC =	0.319	-	XCJC =	0.3904	-
TR =	2.71	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	NK =	0.5	-	EG =	1.11	eV
XTI =	0	-	FC =	0.735		TNOM	300	K

All parameters are ready to use, no scaling is necessary. Extracted on behalf of Infineon Technologies AG by:  
Institut für Mobil- und Satellitentechnik (IMST)

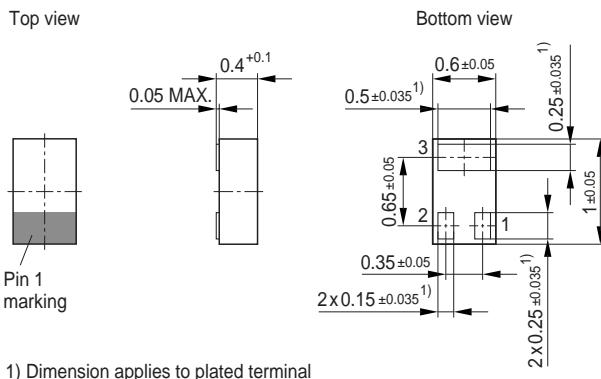
**Package Equivalent Circuit:**


$L_1$ =	0.575	nH
$L_2$ =	0.575	nH
$L_3$ =	0.275	nH
$C_1$ =	33	fF
$C_2$ =	28	fF
$C_3$ =	131	fF
$C_4$ =	8	fF
$C_5$ =	8	fF
$C_6$ =	24	fF
$C_7$ =	300	fF
$R_1$ =	204	$\Omega$

Valid up to 6GHz

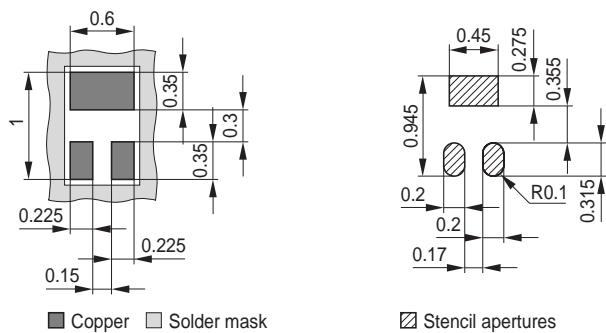
For examples and ready to use parameters  
please contact your local Infineon Technologies  
distributor or sales office to obtain a Infineon  
Technologies CD-ROM or see Internet:  
<http://www.infineon.com>

## Package Outline

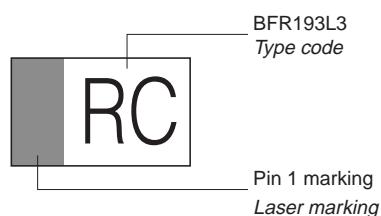


## Foot Print

For board assembly information please refer to Infineon website "Packages"

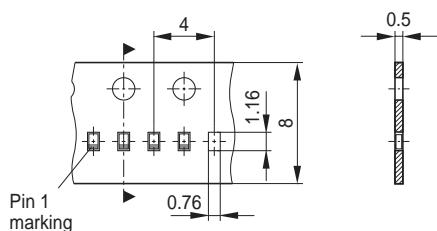


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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